

XI'AN IR-PERI



PRELIMINARY

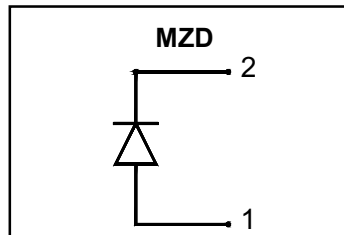
MZD450DD120S

Fast Recovery Epitaxial Diode DOUBLE INT -A -PAK

Soft-Fast™ Speed FRED

### Features

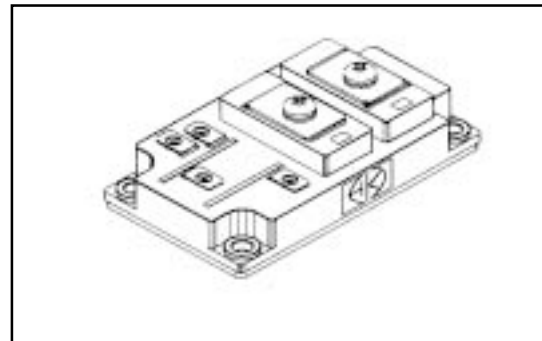
- International standard package  
With DBC ceramic base plate
- Planar passivated chips
- Short recovery time
- Low switching losses
- Ultra-soft recovery behaviour
- Industry standard package
- UL recognition pending



**V<sub>RRM</sub> = 1200V**  
**I<sub>FAVM</sub> = 450A**  
**t<sub>rr</sub> = 550ns**

### Benefits

- Antiparallel diode for high frequency switching devices
- Increased operating efficiency
- Direct mounting to heatsink
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders
- Low voltage peaks for reduced protection circuits



### Absolute Maximum Ratings

Symbol	Test Conditions	Max.	Units
V <sub>RSM</sub> & V <sub>RRM</sub>		1200	V
I <sub>FRMS</sub>	T <sub>C</sub> =75°C	700	A
I <sub>FAVM</sub>	T <sub>C</sub> =75°C; rectangular, d=0.5	500	A
I <sub>FRM</sub>	t <sub>p</sub> <10μs; rep. rating, pulse width limited by T <sub>VJM</sub>	3000	A
I <sub>FSM</sub>	T <sub>VJ</sub> =45°C; t=10ms (50 Hz),sine	6000	A
	t=8.3ms (60 Hz),sine	7000	A
	T <sub>VJ</sub> =150°C; t=10ms (50 Hz),sine	5500	A
	t=8.3ms (60 Hz),sine	6000	A
I <sup>2</sup> t	T <sub>VJ</sub> =45°C; t=10ms (50 Hz),sine	180000	A <sup>2</sup> s
	t=8.3ms (60 Hz),sine	245000	A <sup>2</sup> s
	T <sub>VJ</sub> =150°C; t=10ms (50 Hz),sine	152000	A <sup>2</sup> s
	t=8.3ms (60 Hz),sine	180000	A <sup>2</sup> s
V <sub>ISOL</sub>	RMS Isolation Voltage, Any Terminal To Case, t=1 min	2500	V
P <sub>D</sub>	T <sub>C</sub> =25°C	1800	W
T <sub>J</sub>	Operating Junction Temperature Range	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature Range	-40 to +125	

Thermal / Mechanical Characteristics

	Parameter	Typ.	Max.	Units
R $\theta$ JS	Thermal Resistance, Junction-to- Sink DC	-	0.06	
R $\theta$ JC	Thermal Resistance, Junction-to- Case DC	-	0.05	°C/W
R $\theta$ CS	Thermal Resistance, Case-to- Sink- Module	0.05	-	
	Mouting Torque, Case-to-Heatsink	-	4.0	N.m
	Mouting Torque, Case-to-Terminal 1,2 & 3	-	3.0	
	Weight of Module	400	-	g

Electrical Characteristics (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
VRRM	Reverse Breakdown Voltage	1200	-	-	V	I <sub>R</sub> =20mA
I <sub>R</sub>	Diode Leaking Current	-	-	20	mA	T <sub>VJ</sub> =25 °C V <sub>R</sub> =VRRM
		-	-	5	mA	T <sub>VJ</sub> =25 °C V <sub>R</sub> =0.8VRRM
		-	-	120	mA	T <sub>VJ</sub> =125 °C V <sub>R</sub> =0.8VRRM
V <sub>F</sub>	Diode Forward Voltage	-	-	1.60	V	I <sub>F</sub> =500A; T <sub>VJ</sub> =125 °C
		-	-	1.87	V	T <sub>VJ</sub> = 25 °C
		-	-	1.90	V	I <sub>F</sub> =650A; T <sub>VJ</sub> =125 °C
		-	-	2.24	V	T <sub>VJ</sub> = 25 °C
V <sub>TO</sub>	For power-loss calculations only	-	-	1.18	V	
r <sub>T</sub>		-	-	1.15	mΩ	
trr@T <sub>VJ</sub> =100 °C	Diode Reverse Recovery Time	-	550	600	ns	I <sub>F</sub> =650A
I <sub>RM</sub> @T <sub>VJ</sub> = 25 °C	Diode Peak Reverse Current	-	-	110	A	V <sub>R</sub> =600V
I <sub>RM</sub> @T <sub>VJ</sub> =100 °C	Diode Peak Reverse Current	-	-	165	A	-di/dt=800A/μs

Case Outline - Double int-a-pak

